

Lead-free Epoxy Laminate and Prepreg
Tg 180°C Td 350°C Dk 3.97 Df 0.0200

IPC-4101 /21 /24 /26 /121 /124 /129 UL - File Number E41625

IS410 is a high-performance FR-4 epoxy laminate and prepreg system designed to support the printed circuit board industry's requirements for higher levels of reliability and the trend to use lead free solder.

PRODUCT ATTRIBUTES

LEGACY

PRODUCT FEATURES

Industry Recognition

- UL File Number: E41625
- RoHS Compliant

Performance Attributes

- Lead-free assembly compatible
- 6x 288°C solder float capable

Processing Advantages

FR-4 process compatible

PRODUCT AVAILABILITY

Standard Material Offering: Laminate

- 2 to 125 mil (0.05 to 3.2 mm)
- Available in full size sheet or panel form

Copper Foil Type

- HTE Grade 3
- RTF (Reverse Treat Foil)

Copper Weight

- ½ to 2 oz (18 to 70 μm) available
- Heavier copper available
- Thinner copper foil available

Standard Material Offering: Prepreg

- Roll or panel form
- · Tooling of prepreg panels

Glass Fabric Availability

- · E-glass
- Square weave glass

Isola Group 6565 West Frye RoadChandler, AZ 85226 Phone: 480-893-6527 Fax: 480-893-1409

MEDICAL, INDUSTRIAL & INSTRUMENTATION

Isola Asia Pacific

Isola's IS410 has a glass transition temperature (Tg) of 180°C and is specially

formulated for superior performance through multiple thermal excursions, passing 6X

high aspect ratio holes of \$\times 10\$ mils. Its unique resin chemistry provides CAF resistance

solder tests at 288°C. IS410 is optimized for enhanced drilling performance allowing

with the benefit of long-term reliability of boards built with small feature designs.

(Hong Kong) Ltd.12/F, Kin Sang Commercial Centre, 49 King Yip Street, Kwun Tong, Kowloon,

Hong KongPhone: 852-2418-1318 Fax: 852-2418-1533



TYPICAL MARKET APPLICATIONS





ORDERING INFORMATION:

Contact your local sales representative or contact info@isola-group.com for further information.

Isola GmbH

Isola Strasse 2 D-52348 Düren, GermanyPhone: 49-2421-8080 Fax: 49-2421-808164

Typical Values Table

| | Property | Typical Value | Units | Test Method |
|--|--|---|-----------------------|--|
| | | | Metric (English) | IPC-TM-650 (or as noted) |
| Glass Transition Temperature (Tg) by DSC | | 180 | °C | 2.4.25C |
| Decomposition Temperature (Td) by TGA @ 5% weight loss | | 350 | °C | 2.4.24.6 |
| Time to Delaminate by TMA (Copper removed) | A. T260 B. T288 | 50 10 | Minutes | 2.4.24.1 |
| Z-Axis CTE | A. Pre-Tg B. Post-Tg C. 50 to 260°C, (Total Expansion) | 55 250 3.5 | ppm/°C ppm/°C % | 2.4.24C 2.4.24C |
| X/Y-Axis CTE | Pre-Tg | 11 | ppm/°C | 2.4.24C |
| Thermal Conductivity | | 0.5 | W/m·K | ASTM E1952 |
| Thermal Stress 10 sec @ 288°C (550.4°F) | A. Unetched B. Etched | Pass | Pass Visual | 2.4.13.1 |
| Dk, Permittivity | A. @ 100 MHz B. @ 1 GHz C. @ 2 GHz D. @ 5 GHz E. @ 10 GHz | 3.96 3.90 3.97 3.87 3.87 | - | 2.5.5.3 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline |
| Df, Loss Tangent | A. @ 100 MHz B. @ 1 GHz C. @ 2 GHz D. @ 5 GHz E. @ 10 GHz | 0.0149 0.0189 0.0200 0.0230 0.0230 | _ | 2.5.5.3 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline |
| Volume Resistivity | A. After moisture resistance B. At elevated temperature | 8.0 x 10 ⁸ 3.6 x 10 ⁸ | MM-cm | 2.5.17.1 |
| Surface Resistivity | A. After moisture resistance B. At elevated temperature | 8.0 x 10 ⁶ 4.5 x 10(8) | MM | 2.5.17.1 |
| Dielectric Breakdown | | >50 | kV | _ |
| Arc Resistance | | 129 | Seconds | _ |
| Electric Strength (Laminate & laminated prepreg) | | 44 (1100) | kV/mm (V/mil) | _ |
| Comparative Tracking Index (CTI) | | 3 (175-249) | Class (Volts) | UL 746A ASTM D3638 |
| Peel Strength | A. Low profile copper foil and very low profile copper foil all copper foil >17 \(\text{ Im} \) [0.669 mil] B. Standard profile copper 1. After thermal stress 2. At 125°C (257°F) 3. After process solutions | 1.14 (6.5) 1.225 (7.0) 1.14 (6.5) 0.90 (5.1) | N/mm (lb/inch) | 2.4.8C 2.4.8.2A 2.4.8.3 2.4.8.3 |
| Flexural Strength | A. Length direction B. Cross direction | 82.6 66.4 | ksi | 2.4.4B |
| Tensile Strength | A. Length direction B. Cross direction | 60.9 45.8 | ksi | ASTM D3039 |
| Poisson's Ratio | A. Length direction B. Cross direction | 0.175 0.143 | _ | ASTM D3039 |
| Moisture Absorption | | 0.20 | % | 2.6.2.1A |
| Flammability (Laminate & laminated prepreg) | | V-0 | Rating | UL 94 |
| Relative Thermal Index (RTI) | | 130 | °C | UL 796 |

NOTES

Visit our site http://www.isola-group.com for more details.

Revisions:

A: Initial release - 4/17

B: Corrected units for Flexural and Tensile Strength - 8/18

C: Change MOT to RTI 5/19

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